

### 1 Description

The iW3827 is a high-performance single-stage AC/DC constant voltage (CV) controller with high power factor (PF) correction. This device includes an internal power FET and operates in quasi-resonant mode to provide high efficiency along with a number of key built-in features while minimizing the external component count and lowering the total bill of material cost. It supports most commonly used isolated and non-isolated topologies including flyback, buck-boost, and buck. The device operates in constant on-time mode to achieve high power factor (> 0.9) across a wide load range. It can achieve excellent output voltage regulation over line and load variation without the need for a secondary feedback circuit. It also eliminates the need for external loop compensation while maintaining stability over all operating conditions with different types of loads, including downstream DC-DC converter, constant current (CC) load, LED load, and constant resistive (CR) load.

The iW3827 integrates a proprietary technique that adaptively adjusts output voltage limits to maintain overshoot and undershoot transients to less than 10% of the nominal output voltage for any load transient. The iW3827 operates in pulse-frequency-modulation (PFM) mode at light load to eliminate audible noise, and at the same time achieving less than 200mW no-load standby power consumption.

Dialog's innovative proprietary technology maximizes the iW3827 performance. It provides two multi-function pins that allow users to configure maximum and minimum switching frequencies for design flexibility, with no cost or size impact. In addition to providing input voltage sensing for input under-voltage protection, the  $V_{\rm IN}$  pin also enables the active start-up scheme to achieve the shortest possible start-up time without sacrificing active efficiency.

#### 2 Features

- Supports universal input (90V<sub>AC</sub> 264V<sub>AC</sub>) in flyback, buck-boost and buck topologies
- Internal 650V power MOSFET delivers up to 8W output power
- PrimAccurate<sup>™</sup> primary-side control technology achieves very tight line and load regulation (±3%)
- PF > 0.9 and THD < 20% across a wide output power range
- User-configurable minimum switching frequency (600Hz/1kHz) ensures no-load standby power consumption < 200mW at 230V<sub>AC</sub>
- Internal loop compensation ensures stable operation under all load conditions

- Supports wide range of output capacitance
- Fast dynamic load response
- User-configurable maximum PWM switching frequency (90kHz or 120kHz)
- Built-in soft-start achieves fast and smooth start-up
- Active start-up scheme enables fast start-up
- Built-in single-point fault protection features: output over-load, output over-voltage, output short and input voltage under-voltage protections
- Built-in over-temperature protection

## 3 Applications

- Smart LED lighting
- Front-end pre-regulator





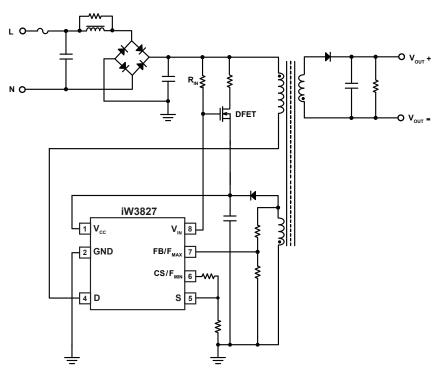


Figure 3.1: iW3827 Typical Application Circuit (Isolated Flyback Application)

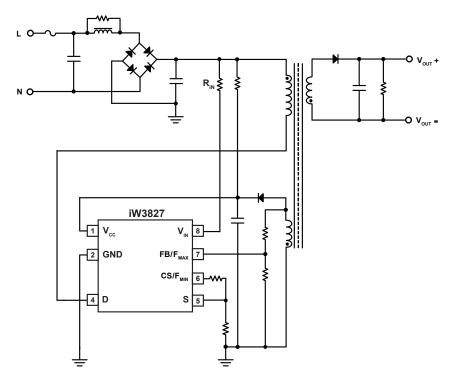


Figure 3.2: iW3827 Typical Application Circuit (Isolated Flyback Application Without Using Active Start-up Device)

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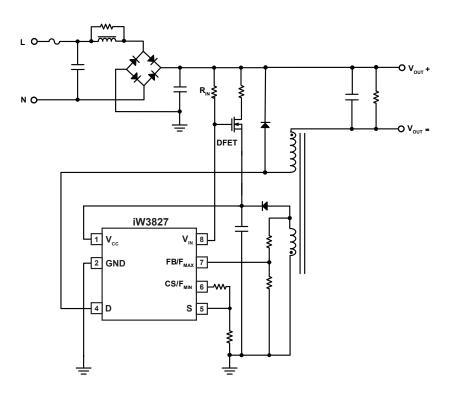


Figure 3.3: iW3827 Typical Application Circuit (Buck Application)

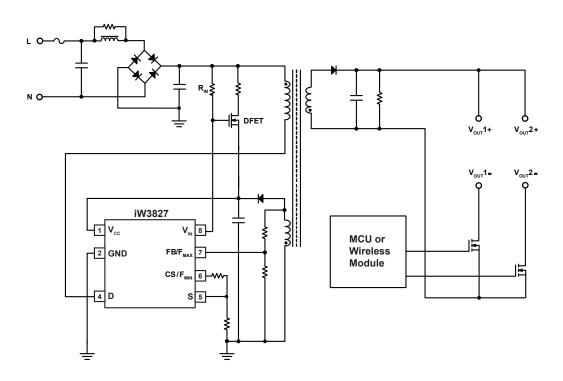


Figure 3.4: iW3827 Typical Application Circuit (Smart Lighting)



## **4 Pinout Description**

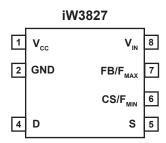


Figure 4.1 : 7-Lead SOIC Package

| Pin Number | Pin Name            | Туре          | Pin Description   |
|------------|---------------------|---------------|---|
| 1          | V <sub>CC</sub>     | Power Input   | Power supply to control logic and MOSFET drive.   |
| 2          | GND                 | Ground        | Ground.   |
| 4          | D                   | MOSFET Drain  | Drain of the internal power MOSFET.   |
| 5          | S                   | MOSFET Source | Source of the internal power MOSFET. Pin 5 and pin 6 can be shorted externally or install one resistor in between for configuration.  |
| 6          | CS/F <sub>MIN</sub> | Analog Input  | Multi-function pin. Used to configure minimum switching frequency ( $F_{\text{MIN}}$ ) at the beginning of the start-up. It also provides primary current sense for cycle-by-cycle peak current control and limit during normal operation.            |
| 7          | FB/F <sub>MAX</sub> | Analog Input  | Multi-function pin. Used to configure maximum switching frequency ( $F_{MAX}$ ), and to enable/disable over-load protection (OLP) at the beginning of start-up. It also provides output voltage sense for primary regulation during normal operation. |
| 8          | $V_{IN}$            | Analog Input  | Multi-function pin. Used to control active start-up device and sense line voltage.  |



## **5 Absolute Maximum Ratings**

Absolute maximum ratings are the parameter values or ranges which can cause permanent damage if exceeded.

| Parameter   | Symbol            | Value        | Units |
|---|-------------------|--------------|-------|
| DC supply voltage range (pin 1, I <sub>CC</sub> = 20mA max)                 | V <sub>cc</sub>   | -0.3 to 18.0 | V     |
| Continuous DC supply current at V <sub>CC</sub> pin (V <sub>CC</sub> = 15V) | I <sub>cc</sub>   | 20           | mA    |
| V <sub>IN</sub> (pin 8)   |                   | -0.3 to 18.0 | V     |
| FB/F <sub>MAX</sub> input (pin 7, I <sub>FB/OTP</sub> ≤ 10mA)               |                   | -0.7 to 4.0  | V     |
| CS/F <sub>MIN</sub> input (pin 6)   |                   | -0.3 to 4.0  | V     |
| Drain-source voltage  | $V_{DSS}$         | 650          | V     |
| Continuous drain current @ T <sub>C</sub> = +25°C                           |                   | 2            | А     |
| Continuous drain current @ T <sub>C</sub> = +100°C                          | l <sub>D</sub>    | 1.2          | А     |
| Pulsed drain current (Note 1)   | I <sub>DM</sub>   | 8            | А     |
| Maximum junction temperature  | $T_JMAX$          | 150          | °C    |
| Operating junction temperature  | T <sub>JOPT</sub> | -40 to 150   | °C    |
| Storage temperature   | T <sub>STG</sub>  | -65 to 150   | °C    |
| ESD rating per JEDEC JESD22-A114  |                   | ±2,000       | V     |
| Latch-up test per JESD78D   |                   | ±100         | mA    |

Note 1. Repetitive rating; pulse width limited by maximum junction temperature.

### **6 Thermal Characteristics**

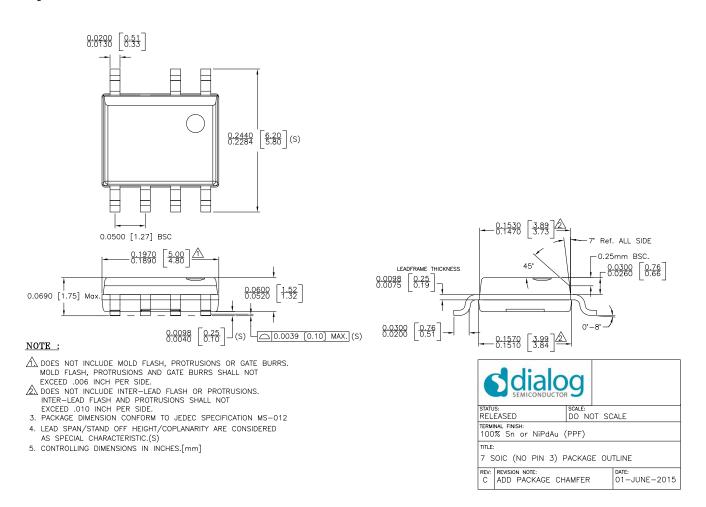
| Parameter   | Symbol                | Value | Units |
|---|-----------------------|-------|-------|
| Thermal Resistance Junction-to-Ambient (Note 1)           | $\theta_{JA}$         | TBD   | °C/W  |
| Thermal Resistance Junction-to-GND pin (pin 2) (Note 2)   | ΨЈВ                   | TBD   | °C/W  |
| Thermal Resistance Junction-to-Drain pin (pin 4) (Note 2) | Ψ <sub>J-MOSFET</sub> | TBD   | °C/W  |
| Thermal Shutdown Threshold (Note 3)                       | T <sub>SD</sub>       | 150   | °C    |
| Thermal Shutdown Recovery (Note 3)                        | T <sub>SD-R</sub>     | 125   | °C    |

#### Notes:

- Note 1.  $\theta_{JA}$  is measured in a one-cubic-foot natural convection chamber.
- Note 2.  $\psi_{JB}$  [Psi Junction to Board] provides an estimation of the die junction temperature relative to the PCB [Board] surface temperature.  $\psi_{J-MOSFET}$  [Psi Junction to Drain pin] provides an estimation of the die junction temperature relative to the Drain pin [internal MOSFET Drain] surface temperature.  $\psi_{JB}$  is measured at the ground pin (pin 2) without using any thermal adhesives.
- Note 3. These parameters are typical and they are guaranteed by design.



### 7 Physical Dimensions



## **8 Ordering Information**

| Part Number | Description | Package | Description              |
|-------------|-------------|---------|--------------------------|
| iW3827-01   |             | SOIC-7  | Tape & Reel <sup>1</sup> |

Note 1. Tape & Reel packing quantity is 2,500/reel. Minimum packing quantity is 2,500.

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### **Corporate Headquarters**

TOYOSU FORESIA, 3-2-24 Toyosu Koto-ku, Tokyo 135-0061, Japan www.renesas.com

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